



### 20V P-Channel Enhancement Mode MOSFET - ESD Protected

Voltage

-20 V

Current

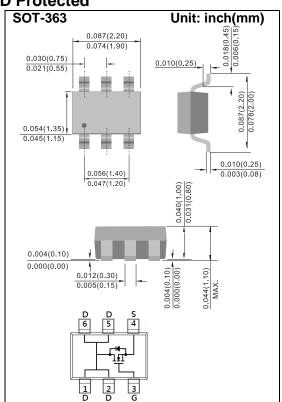
-2.5A

#### **Features**

- RDS(ON), VGS@-4.5V, ID@-2.5A<85mΩ
- RDS(ON), VGS@-2.5V, ID@-1.8A<115mΩ</li>
- RDS(ON), VGS@-1.8V, ID@-1.3A<150mΩ</li>
- RDS(ON), VGS@-1.5V, ID@-0.5A<250mΩ</li>
- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc.
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

#### **Mechanical Data**

- Case: SOT-363 Package
- Terminals: Solderable per MIL-STD-750, Method 2026



# Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25 °C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V <sub>DS</sub>	-20	V
Gate-Source Voltage		$V_{GS}$	<u>+</u> 12	V
Continuous Drain Current		I <sub>D</sub>	-2.5	Α
Pulsed Drain Current (Note 4)		I <sub>DM</sub>	-10	Α
Power Dissipation	T <sub>a</sub> =25°C	P <sub>D</sub>	750	mW
	Derate above 25°C		6	mW/°C
Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~150	°C
Typical Thermal Resistance				
- Junction to Ambient (Note 3)		$R_{\theta JA}$	167	°C/W





# Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}$ =0V, $I_D$ =-250uA	-20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250uA$	-0.4	-0.65	-1.2	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2.5A	-	76	85	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1.8A	-	92	115	
		V <sub>GS</sub> =-1.8V, I <sub>D</sub> =-1.3A	-	116	150	
		V <sub>GS</sub> =-1.5V, I <sub>D</sub> =-0.5A	-	160	250	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V	-	-0.01	-1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = <u>+</u> 12V, V <sub>DS</sub> =0V	-	<u>+</u> 10	<u>+</u> 100	nA
Dynamic <sup>(Note 5)</sup>						
Total Gate Charge	$Q_g$	V <sub>DS</sub> =-10V, I <sub>D</sub> =-2.2A, V <sub>GS</sub> =-4.5V <sup>(Note 1,2)</sup>	-	7	-	nC
Gate-Source Charge	$Q_gs$		-	1	-	
Gate-Drain Charge	$Q_{gd}$		-	1.8	-	
Input Capacitance	Ciss	101/1/1/01/	-	522	-	pF
Output Capacitance	Coss	V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, f=1.0MHZ	-	55	-	
Reverse Transfer Capacitance	Crss		-	40	-	
Turn-On Delay Time	td <sub>(on)</sub>	$V_{DD}$ =-10V, $I_{D}$ =-2.2A, $V_{GS}$ =-4.5V, $R_{G}$ =6 $\Omega$ (Note 1,2)	-	10	-	
Turn-On Rise Time	tr		-	4	-	ns
Turn-Off Delay Time	td <sub>(off)</sub>		-	34	-	
Turn-Off Fall Time	tf		-	5	-	
Drain-Source Diode						
Maximum Continuous Drain-Source			-	-	-1.0	А
Diode Forward Current	I <sub>S</sub>					
Diode Forward Voltage	$V_{\mathtt{SD}}$	I <sub>S</sub> =-1.0A, V <sub>GS</sub> =0V	-	-0.77	-1.2	V

#### NOTES:

- 1. Pulse width<a></a>300us, Duty cycle<a></a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. R<sub>OJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing





#### **TYPICAL CHARACTERISTIC CURVES**

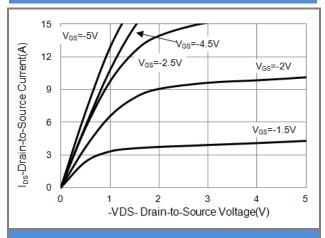
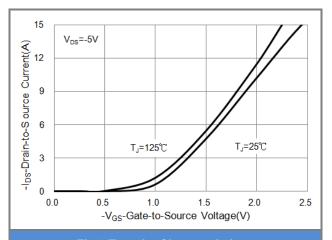


Fig.1 On-Region Characteristics



**Fig.2 Transfer Characteristics** 

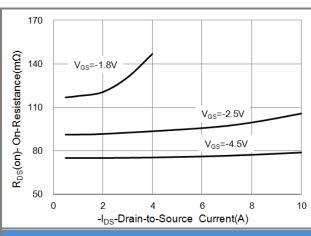


Fig.3 On-Resistance vs. Drain Current

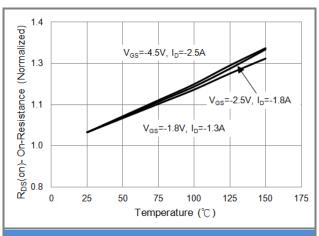


Fig.4 On-Resistance vs. Junction temperature

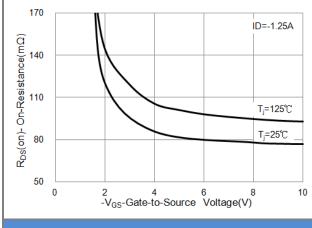


Fig.5 On-Resistance Variation with VGS.

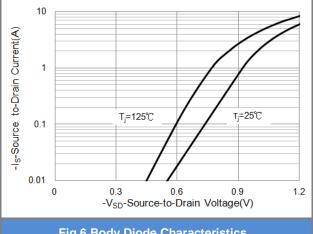
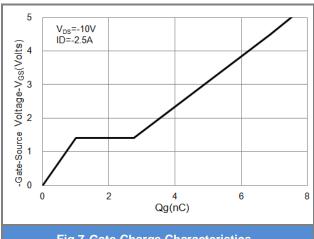


Fig.6 Body Diode Characteristics





### **TYPICAL CHARACTERISTIC CURVES**



**Fig.7 Gate-Charge Characteristics** 

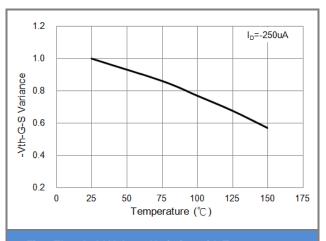


Fig.8 Threshold Voltage Variation with Temperature.

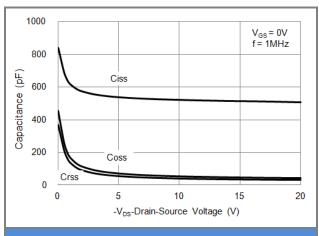


Fig.9 Capacitance vs. Drain-Source Voltage.

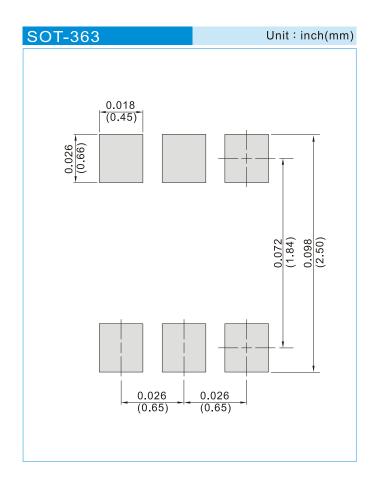




### PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJT7413_S1_00001	SOT-363	3K pcs / 7" reel	T13	Halogen free
PJT7413_S2_00001	SOT-363	10K pcs / 13" reel	T13	Halogen free

### **MOUNTING PAD LAYOUT**







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